
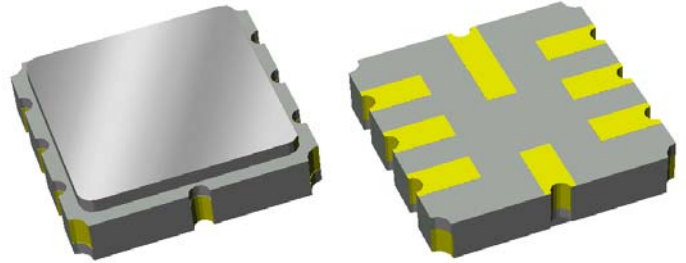


Preliminary Data Sheet

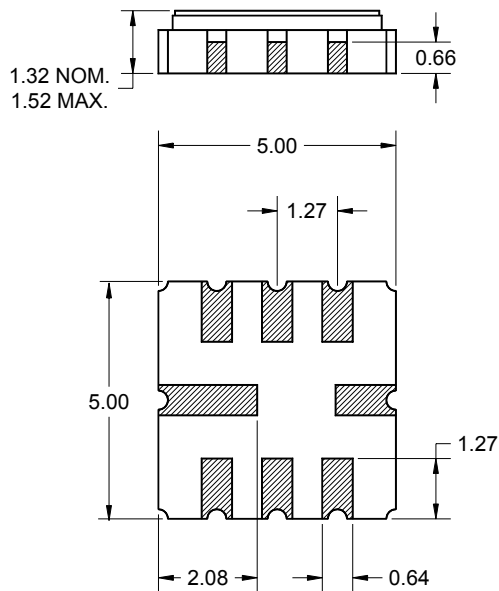
Features

- WiMAX & Broadband Wireless applications
- High attenuation
- Single-ended operation
- Ceramic Surface Mount Package (SMP)
- Hermetic
- RoHS compliant (2002/95/EC), Pb-free 



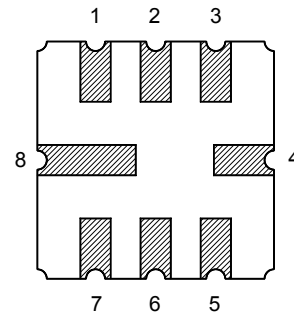
Package

Surface Mount 5.00 x 5.00 x 1.32 mm



Pin Configuration

Bottom View



Pin No.	Description
7	Input
3	Output
1,5	Ground
2,4,6,8	Case ground

Dimensions shown are nominal in millimeters
 All tolerances are ± 0.15 mm except overall
 length and width ± 0.13 mm

Body: Al_2O_3 ceramic
 Lid: Kovar, Ni plated
 Terminations: Au plating 0.5 - 1.0 μ m,
 over a 2 - 6 μ m Ni plating

Preliminary Data Sheet

Target Electrical Specifications ^(1,2)

Operating Temperature Range: ⁽³⁾ -40 to +85 °C

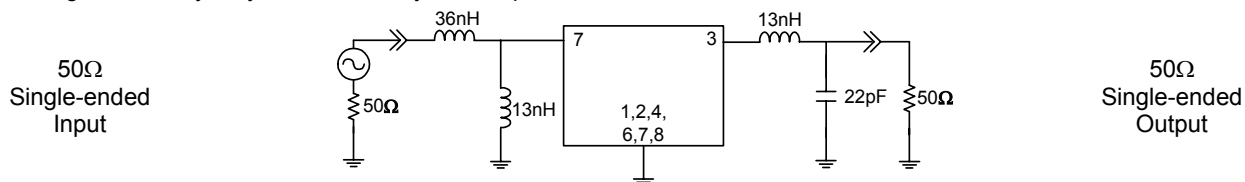
Parameter	Minimum	Typical	Maximum	Unit
Center Frequency	-	520	-	MHz
Insertion Loss at Center Frequency	-	10.8	12.25	dB
Lower 1 dB Bandedge ⁽⁴⁾	-	516.74	517.5	MHz
Upper 1 dB Bandedge	522.5	523.01	-	MHz
1 dB Bandwidth ⁽⁴⁾	6	6.2	-	MHz
3 dB Bandwidth ⁽⁴⁾	6.9	7.09	-	MHz
10 dB Bandwidth ⁽⁴⁾	-	8.15	9.3	MHz
30 dB Bandwidth ⁽⁴⁾	-	11.3	11.8	MHz
Amplitude Variation ⁽⁵⁾ 517 - 523 MHz	-	1.05	2.0	dB p-p
Group Delay Variation ⁽⁵⁾ 517 - 523 MHz	-	125	200	ns p-p
Relative Attenuation ⁽⁴⁾ 10.0 - 350.0 MHz	45	55	-	dB
350.0 - 480.0 MHz	40	50	-	dB
480.0 - 514.1 MHz	30	37	-	dB
525.9 - 600.0 MHz	30	37	-	dB
600.0 - 800.0 MHz	30	55	-	dB
Source Impedance	-	50	-	Ω
Load Impedance	-	50	-	Ω

Notes:

1. All specifications are based on the test circuit shown below
2. In production, devices will be tested at room temperature to a guardbanded specification to ensure electrical compliance over temperature
3. Electrical margin has been built into the design to account for the variations due to manufacturing tolerances
4. All attenuation measurements are referenced to IL at Center Frequency
5. Variation is defined as the total peak to peak variation over the defined frequency range

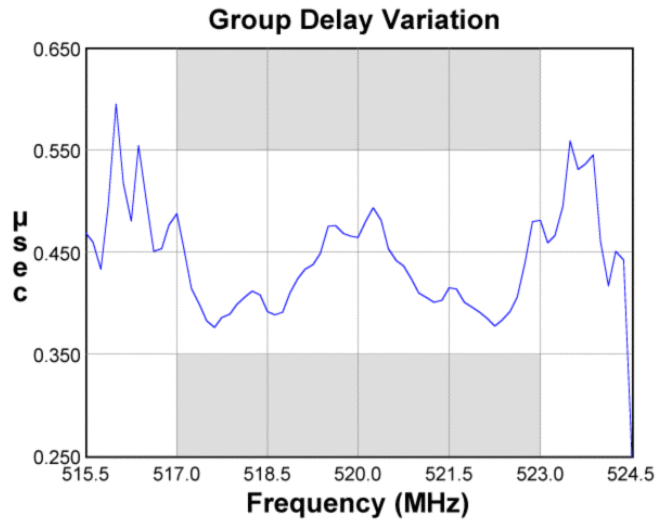
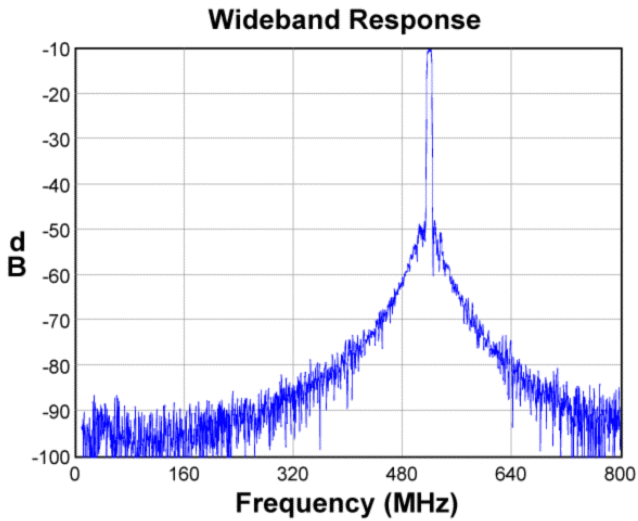
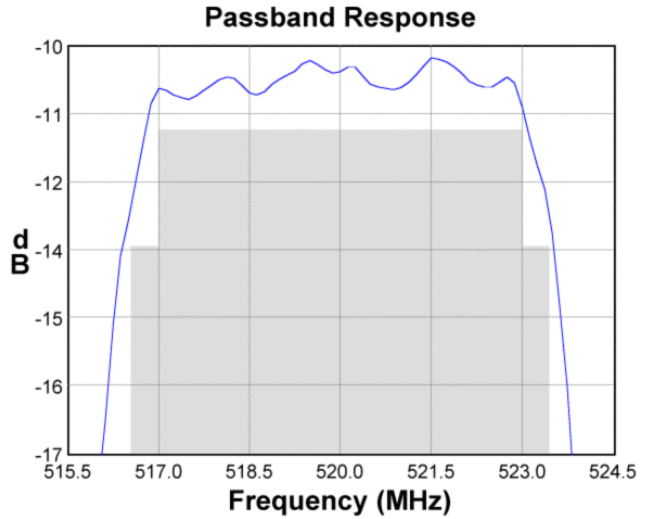
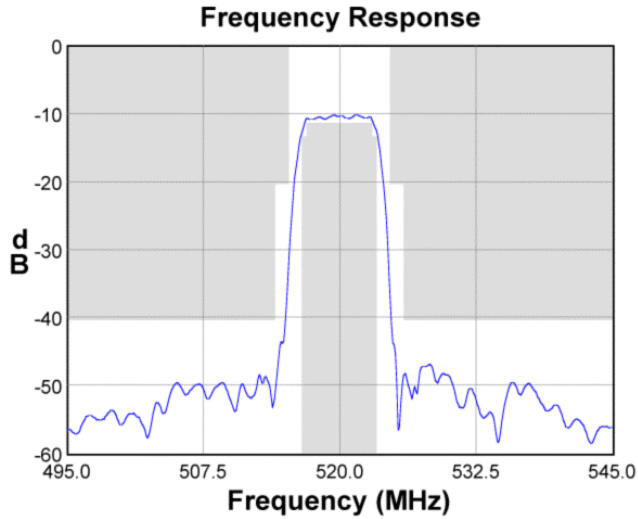
Test Circuit:

Actual matching values may vary due to PCB layout and parasitics

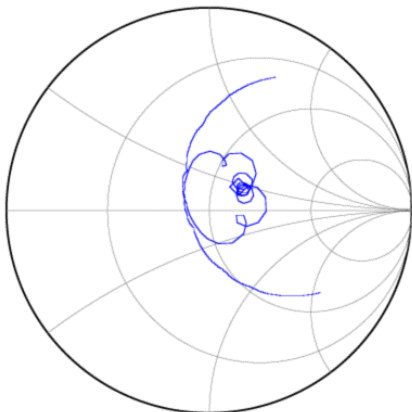


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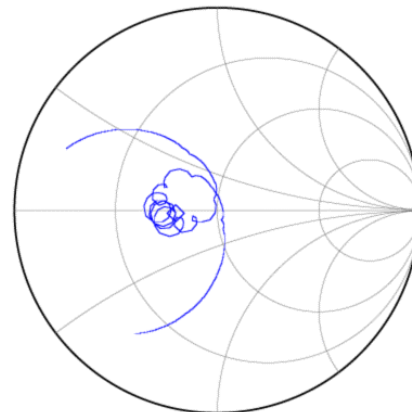
Typical Performance (at +25°C)



Input Smith Chart



Output Smith Chart




Preliminary Data Sheet

Maximum Ratings


Parameter	Symbol	Minimum	Maximum	Unit
Operating Temperature Range	T	-40	+85	°C
Storage Temperature Range	T _{stg}	-40	+85	°C

Important Notes

Warnings

- Electrostatic Sensitive Device (ESD) 
- Avoid ultrasonic exposure

RoHS Compliance

- This product complies with EU directive 2002/95/EC (RoHS) 

Solderability

- Compatible with JEDEC J-STD-020C **Pb**-free process, **260°C** peak reflow temperature

Links to Additional Technical Information

[PCB Layout Tips](#)

[Qualification Flowchart](#)

[Soldering Profile](#)

[S-Parameters](#)

[RoHS Information](#)

[Other Technical Information](#)

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